Multilayer Ceramic Chip Capacitors

C3225JB1A226M250AA



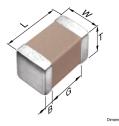






TDK item description C3225JB1A226MT****

Applications	Commercial Grade	
Feature	General General (Up to 50V)	
Series	C3225 [EIA 1210]	
Status	Production (Not Recommended for New Design)	



	Size	
Length(L)	3.20mm ±0.40mm	
Width(W)	2.50mm ±0.30mm	
Thickness(T)	2.50mm ±0.30mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)		
Recommended Land Pattern (PA)	2.00mm to 2.40mm	
Recommended Land Pattern (PB)	1.00mm to 1.20mm	_
Recommended Land Pattern (PC)	1.90mm to 2.50mm	

	Electrical Characteristics	
Capacitance	22µF ±20%	
Rated Voltage	10VDC	
Temperature Characteristic	JB(±10%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	4ΜΩ	

Other		
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Blister (Plastic)Taping [180mm Reel]	
Package Quantity	1000pcs	

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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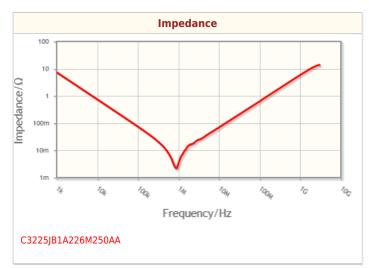


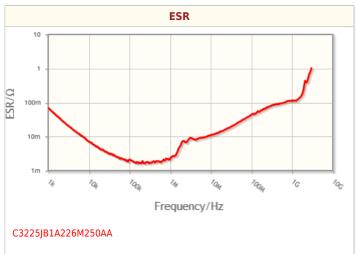


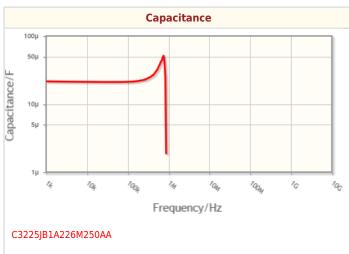


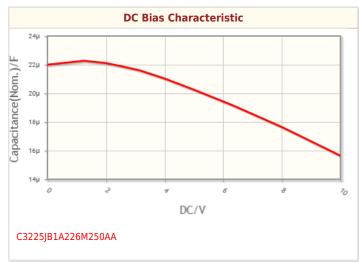


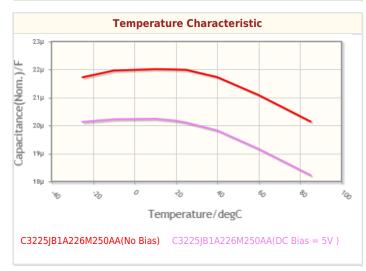
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

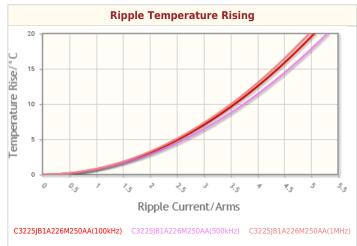












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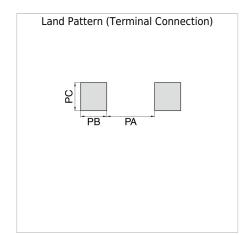








Associated Images



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